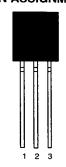


DS18105V EconoReset with Push–Pull Output

FEATURES

- Automatically restarts a microprocessor after power failure
- Maintains reset for 150 ms after V_{CC} returns to an intolerance condition
- Reduces need for discrete components
- Precision temperature—compensated voltage reference and voltage sensor
- Low-cost TO-92 or space saving surface mount SOT-23 packages available
- Push-Pull output for low current operation
- Operating temperature –40°C to +85°C

PIN ASSIGNMENT







TO-92 PACKAGE See Mech. Drawings Section

PIN DESCRIPTIONS

TO-92

1 RST Active Low Reset Output

2 V_{CC} Power Supply

3 GND Ground

SOT-23

1 RST Active Low Reset Output

2 V_{CC} Power Supply

3 GND Ground

DESCRIPTION

The DS1810 EconoReset uses a precision temperature reference and comparator circuit to monitor the status of the power supply (V_{CC}). When an out–of–tolerance condition is detected, an internal power–fail signal is

generated which forces reset to the active state. When V_{CC} returns to an in–tolerance condition, the reset signal is kept in the active state for approximately 150 ms to allow the power supply and processor to stabilize.

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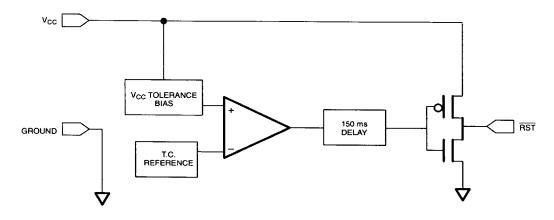
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OPERATION - POWER MONITOR

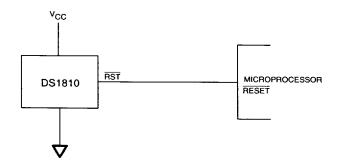
The DS1810 provides the function of detecting out–of–tolerance power supply conditions and warning a processor–based system of impending power failure. When $V_{\rm CC}$ is detected as out–of–tolerance, the $\overline{\rm RST}$

signal is asserted. On power–up, RST is kept active for approximately 150 ms after the power supply has reached the selected tolerance. This allows the power supply and microprocessor to stabilize before RST is released.

BLOCK DIAGRAM (PUSH-PULL OUTPUT) Figure 1



APPLICATION EXAMPLE Figure 2



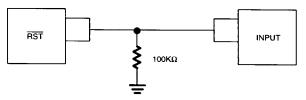
OUTPUT VALID CONDITIONS

All versions of the DS1810 can maintain a valid output as long as V_{CC} remains above 1.2 volt. However, the \overline{RST} outputs on the DS1810 use a push–pull structure which can maintain a valid output below 1.2 volt on an input. To sink current below 1.2 volt, a resistor can be

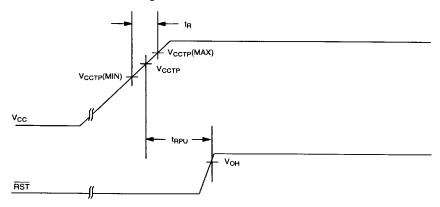
connected from \overline{RST} to Ground (see Figure 3). This arrangement will maintain a valid value on the \overline{RST} outputs even it V_{CC} approaches 0 volts. During both power up and down this arrangement will draw current when \overline{RST} is in the high state. A value of about $100 \text{K}\Omega$ should be adequate to maintain a valid condition.

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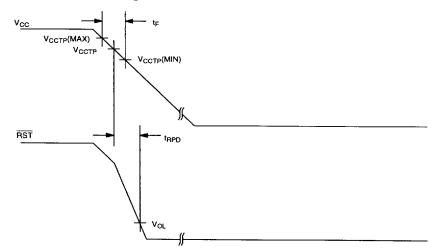
APPLICATION DIAGRAM: RST VALID TO 0 VOLTS VCC ON THE DS1810 Figure 3



TIMING DIAGRAM: POWER UP Figure 4



TIMING DIAGRAM: POWER DOWN Figure 5



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ABSOLUTE MAXIMUM RATINGS*

Voltage on V_{CC} Pin Relative to Ground Voltage on RST Relative to Ground Operating Temperature Storage Temperature

Soldering Temperature

-0.5V to +7.0V -0.5V to V_{CC} +0.5V -40°C to +85°C -55°C to +125°C 260°C for 10 seconds

RECOMMENDED DC OPERATING CONDITIONS

(-40°C to +85°C)

PARAMETER	SYMBOL	MIN	TYP	MAX	UNITS	NOTES
Supply Voltage	Vcc	1.2		5.5	V	1

DC ELECTRICAL CHARACTERISTICS

 $(-40^{\circ}\text{C to } +85^{\circ}\text{C}; \text{ V}_{\text{CC}} = 1.2\text{V to } 5.5\text{V})$

PARAMETER	SYMBOL	MIN	TYP	MAX	UNITS	NOTES
Output Voltage @ 0–500 μA	V _{OH}	V _{CC} -0.5V	V _{CC} -0.1V		٧	1
Output Current @ 2.4 volts	Гон		350		μА	2
Output Current @ 0.4 volts	loL	+10	, , ,		mA	2
Operating Current V _{CC} <5.5	lcc		30	40	μА	3
V _{CC} Trip Point (DS1810-5)	V _{CCTP}	4.50	4.62	4.75	V	1
V _{CC} Trip Point (DS1810–10)	V _{CCTP}	4.25	4.37	4.49	V	1
V _{CC} Trip Point (DS1810–15)	V _{CCTP}	4.00	4.12	4.24	V	1
Output Capacitance	C _{OUT}			10	pF	

AC ELECTRICAL CHARACTERISTICS

 $(-40^{\circ}\text{C to } +85^{\circ}\text{C}; V_{CC} = 1.2\text{V to } 5.5\text{V})$

PARAMETER	SYMBOL	MIN	TYP	MAX	UNITS	NOTES
RESET Active Time	t _{RST}	100	150	300	ms	
V _{CC} Detect to RST	t _{RPD}		2	5	μs	
V _{CC} Slew Rate (V _{CCTP} (MAX) to V _{CCTP} (MIN))	t _F	300			μs	
V _{CC} Slew Rate (V _{CCTP} (MIN) to V _{CCTP} (MAX))	t _R	0			ns	
V _{CC} Detect to RST	t _{RPU}	100	150	300	ms	4

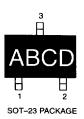
NOTES:

- 1. All voltages are referenced to ground.
- 2. Measured with $V_{CC} \ge 2.7$ volts.
- 3. Measured with $\overline{\text{RST}}$ output open.
- 4. $t_R = 5 \mu s$.

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^{*} This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operation sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods of time may affect reliability.

PART MARKING CODES



"A", "B", & "C" represents the Device Type.

810 DS1810 811 DS1811 812 DS1812 813 DS1813 815 DS1815 816 DS1816 817 DS1817 818 DS1818 "D" represents the Device Tolerance.

A – 5% B – 10% C – 15% D – 20%

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